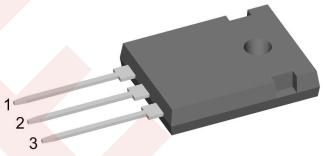
# FRED

$V_{RRM}$ = 200 V
$I_{FAV}$ = 2x 30 A
$t_{rr}$ = 20 ns

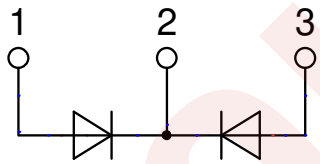
## Fast Recovery Epitaxial Diode
## Common Cathode

**Part number**

**DSEK60-02A**




Backside: cathode




**Features / Advantages:**

- Planar passivated chips
- Low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low Irm-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low Irm reduces:
  - Power dissipation within the diode
  - Turn-on loss in the commutating switch

**Applications:**

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

**Package:** TO-247

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

OBSOLETE

**Disclaimer Notice**

Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at www.littelfuse.com/disclaimer-electronics.



© 2020 IXYS all rights reserved

## Fast Diode

| Symbol | Definition | Conditions | | Ratings min. | typ. | max. | Unit |
|---|---|---|---|---|---|---|---|
| $V_{RSM}$ | *max. non-repetitive reverse blocking voltage* | | $T_{VJ}$ = 25°C | | | 200 | V |
| $V_{RRM}$ | *max. repetitive reverse blocking voltage* | | $T_{VJ}$ = 25°C | | | 200 | V |
| $I_R$ | *reverse current, drain current* | $V_R$ = 200 V | $T_{VJ}$ = 25°C | | | 200 | µA |
| | | $V_R$ = 160 V | $T_{VJ}$ = 125°C | | | 5 | mA |
| $V_F$ | *forward voltage drop* | $I_F$ = 30 A | $T_{VJ}$ = 25°C | | | 1.16 | V |
| | | $I_F$ = 60 A | | | | 1.29 | V |
| | | $I_F$ = 30 A | $T_{VJ}$ = 150°C | | | 0.92 | V |
| | | $I_F$ = 60 A | | | | 1.09 | V |
| $I_{FAV}$ | *average forward current* | $T_C$ = 125°C | $T_{VJ}$ = 150°C | | | 30 | A |
| | | rectangular d = 0.5 | | | | | |
| $V_{F0}$ | *threshold voltage* } *for power loss calculation only* | | $T_{VJ}$ = 150°C | | | 0.78 | V |
| $r_F$ | *slope resistance* } | | | | | 4.9 | mΩ |
| $R_{thJC}$ | *thermal resistance junction to case* | | | | | 0.8 | K/W |
| $R_{thCH}$ | *thermal resistance case to heatsink* | | | | 0.25 | | K/W |
| $P_{tot}$ | *total power dissipation* | | $T_C$ = 25°C | | | 155 | W |
| $I_{FSM}$ | *max. forward surge current* | t = 10 ms; (50 Hz), sine; $V_R$ = 0 V | $T_{VJ}$ = 45°C | | | 325 | A |
| $C_J$ | *junction capacitance* | $V_R$ = 200 V f = 1 MHz | $T_{VJ}$ = 25°C | | 77 | | pF |
| $I_{RM}$ | *max. reverse recovery current* | | $T_{VJ}$ = 25 °C | | 4 | | A |
| | | $I_F$ = 35 A; $V_R$ = 100 V | $T_{VJ}$ = 125 °C | | 6 | | A |
| $t_{rr}$ | *reverse recovery time* | $-di_F/dt$ = 200 A/µs | $T_{VJ}$ = 25 °C | | 20 | | ns |
| | | | $T_{VJ}$ = 125 °C | | 45 | | ns |

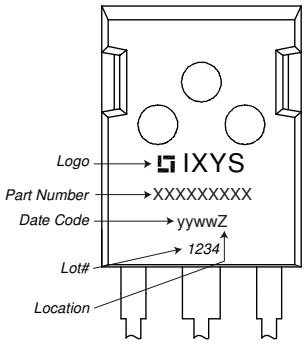
OBSOLETE



© 2020 IXYS all rights reserved

| Package TO-247 | | | Ratings | | | |
|---|---|---|---|---|---|---|
| **Symbol** | **Definition** | **Conditions** | **min.** | **typ.** | **max.** | **Unit** |
| $I_{RMS}$ | *RMS current* | per terminal [1] | | | 70 | A |
| $T_{VJ}$ | *virtual junction temperature* | | -40 | | 150 | °C |
| $T_{op}$ | *operation temperature* | | -40 | | 125 | °C |
| $T_{stg}$ | *storage temperature* | | -40 | | 150 | °C |
| **Weight** | | | | 6 | | g |
| $M_D$ | *mounting torque* | | 0.8 | | 1.2 | Nm |
| $F_C$ | *mounting force with clip* | | 20 | | 120 | N |

Product Marking

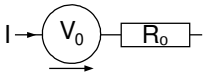



| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|---|---|---|---|---|---|
| Standard | DSEK60-02A | DSEK60-02A | Tube | 30 | 471526 |

| Similar Part | Package | Voltage class |
|---|---|---|
| DSEK60-02AR | ISOPLUS247 (3) | 200 |

## Equivalent Circuits for Simulation

** on die level* $T_{VJ} = 150°C$



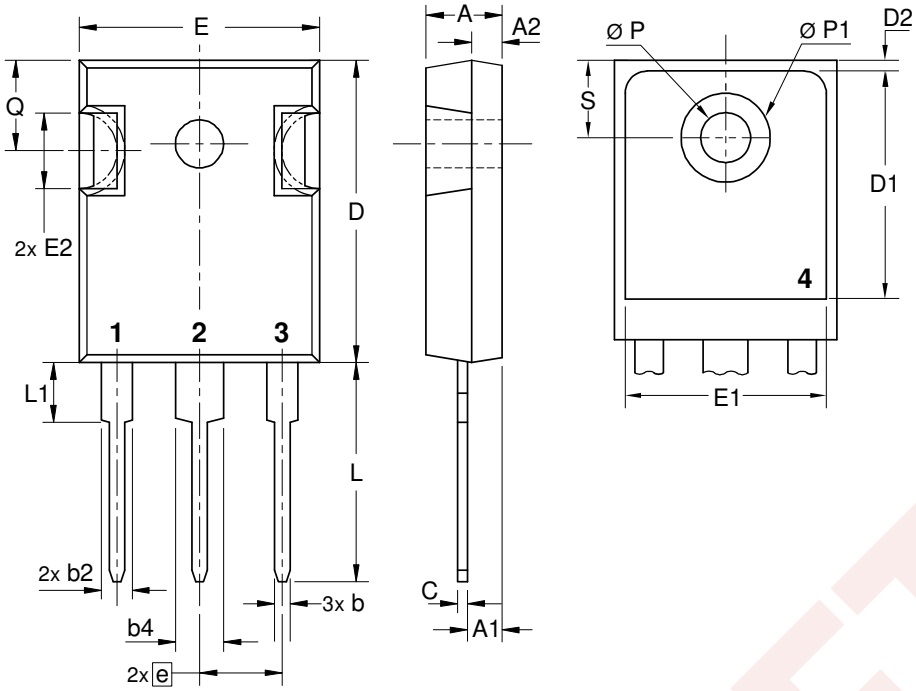

| | | Fast Diode | |
|---|---|---|---|
| $V_{0\,max}$ | *threshold voltage* | 0.78 | V |
| $R_{0\,max}$ | *slope resistance ** | 2.4 | mΩ |

OBSOLETE



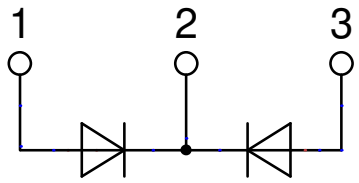
© 2020 IXYS all rights reserved

## Outlines TO-247




| Sym. | Inches | | Millimeter | |
|---|---|---|---|---|
| | min. | max. | min. | max. |
| A | 0.185 | 0.209 | 4.70 | 5.30 |
| A1 | 0.087 | 0.102 | 2.21 | 2.59 |
| A2 | 0.059 | 0.098 | 1.50 | 2.49 |
| D | 0.819 | 0.845 | 20.79 | 21.45 |
| E | 0.610 | 0.640 | 15.48 | 16.24 |
| E2 | 0.170 | 0.216 | 4.31 | 5.48 |
| e | 0.215 BSC | | 5.46 BSC | |
| L | 0.780 | 0.800 | 19.80 | 20.30 |
| L1 | - | 0.177 | - | 4.49 |
| Ø P | 0.140 | 0.144 | 3.55 | 3.65 |
| Q | 0.212 | 0.244 | 5.38 | 6.19 |
| S | 0.242 BSC | | 6.14 BSC | |
| b | 0.039 | 0.055 | 0.99 | 1.40 |
| b2 | 0.065 | 0.094 | 1.65 | 2.39 |
| b4 | 0.102 | 0.135 | 2.59 | 3.43 |
| c | 0.015 | 0.035 | 0.38 | 0.89 |
| D1 | 0.515 | - | 13.07 | - |
| D2 | 0.020 | 0.053 | 0.51 | 1.35 |
| E1 | 0.530 | - | 13.45 | - |
| Ø P1 | - | 0.29 | - | 7.39 |

OBSOLETE






© 2020 IXYS all rights reserved

## Fast Diode

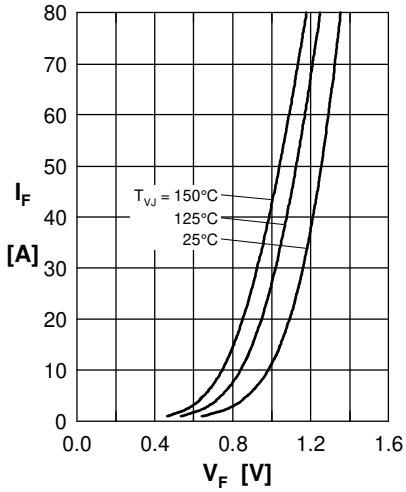



Fig. 1 Forward current $I_F$ versus max. forward Voltage drop $V_F$

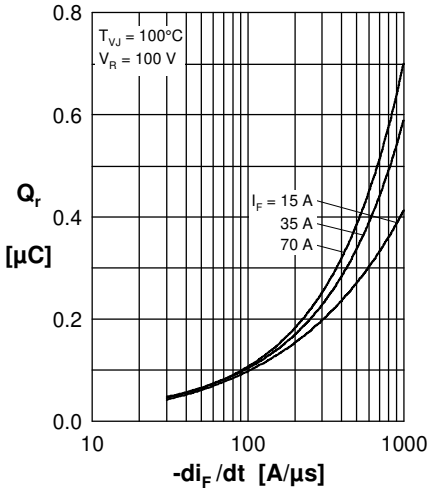



Fig. 2 Typ. reverse recov. charge $Q_r$ versus $-di_F/dt$

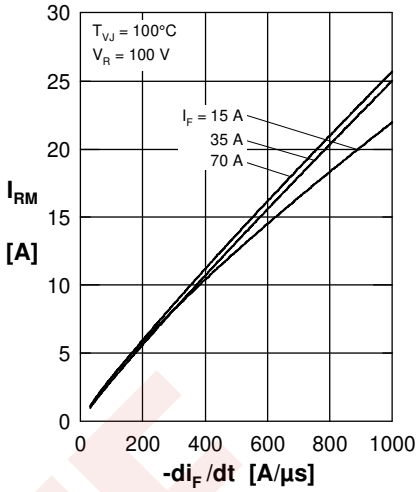



Fig. 3 Typ. peak reverse current $I_{RM}$ versus $-di_F/dt$

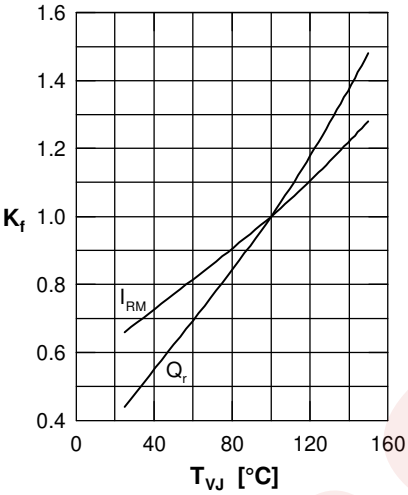



Fig. 4 Typ. dynamic parameters $Q_r$, $I_{RM}$ versus $T_{VJ}$

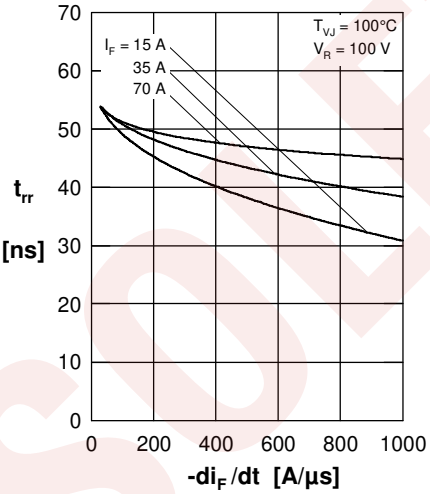



Fig. 5 Typ. recovery time $t_{rr}$ versus $-di_F/dt$

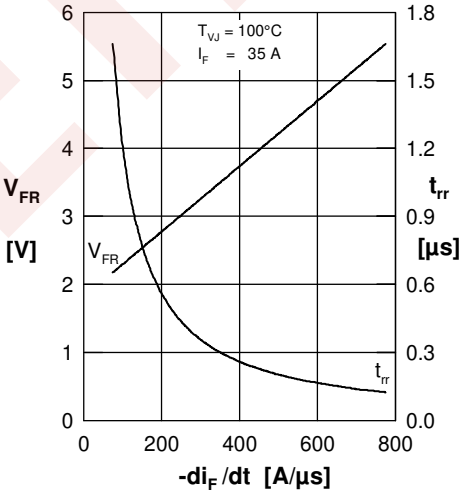



Fig. 6 Typ. peak forward voltage $V_{FR}$ and $t_{fr}$ versus $-di_F/dt$

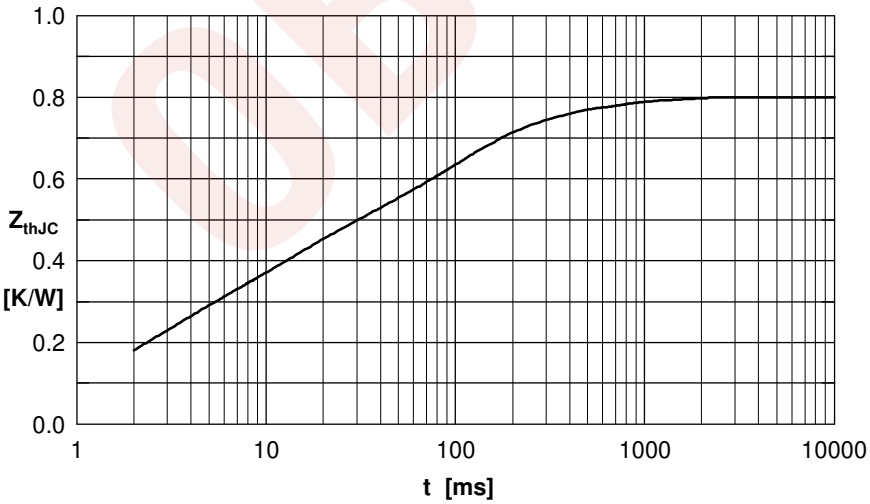



Fig. 7 Transient thermal resistance junction to case

Constants for $Z_{thJC}$ calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|---|---|
| 1 | 0.200 | 0.0018 |
| 2 | 0.220 | 0.0100 |
| 3 | 0.080 | 0.5000 |
| 4 | 0.300 | 0.0900 |

OBSOLETE



© 2020 IXYS all rights reserved